Dual D-Type Positive Edge-Triggered Flip-Flop

The SN74LS74A dual edge-triggered flip-flop utilizes Schottky TTL circuitry to produce high speed D-type flip-flops. Each flip-flop has individual clear and set inputs, and also complementary Q and \overline{Q} outputs.

Information at input D is transferred to the Q output on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level of the clock pulse and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the HIGH or the LOW level, the D input signal has no effect.



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> LOW **POWER SCHOTTKY**

MODE SELECT – TRUTH TABLE

OPERATING MODE		INPUTS	OUTPUTS		
OPERATING WIDDE	S _D	S _D	D	Q	Q
Set	L	Н	Х	Н	L
Reset (Clear)	Н	L	Χ	L	Н
*Undetermined	L	L	Χ	Н	Н
Load "1" (Set)	Н	Н	h	Н	L
Load "0" (Reset)	Н	Н	I	L	Н

Both outputs will be HIGH while both \overline{S}_D and \overline{C}_D are LOW, but the output states are unpredictable if \overline{S}_D and \overline{C}_D go HIGH simultaneously. If the levels at the set and clear are near V_{IL} maximum then we cannot guarantee to meet the minimum level for VOH.

H, h = HIGH Voltage Level

L, I = LOW Voltage Level

X = Don't Care

I, h (q) = Lower case letters indicate the state of the referenced input (or output) one set-up time prior to the HIGH to LOW clock transition.



N SUFFIX CASE 646



SOIC **D SUFFIX CASE 751A**

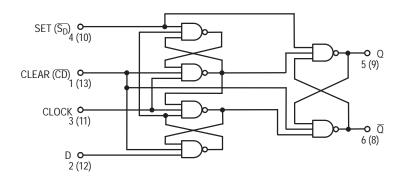
GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-0.4	mA
I _{OL}	Output Current – Low			8.0	mA

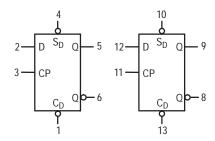
ORDERING INFORMATION

Device	Package	Shipping
SN74LS74AN	14 Pin DIP	2000 Units/Box
SN74LS74AD	14 Pin	2500/Tape & Reel

LOGIC DIAGRAM (Each Flip-Flop)



LOGIC SYMBOL



V_{CC} = PIN 14 GND = PIN 7

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Co	onditions		
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs			
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs			
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	–18 mA		
V _{OH}	Output HIGH Voltage	2.7	3.5		V	$V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH}$ or V_{IL} per Truth Table			
.,			0.25	0.4	V	I _{OL} = 4.0 mA	$V_{CC} = V_{CC} MIN,$		
V _{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 8.0 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table		
I _{IH}	Input High Current Data, Clock Set, Clear			20 40	μΑ	$V_{CC} = MAX, V_{IN} = 2.7 V$			
	Data, Clock Set, Clear			0.1 0.2	mA	V _{CC} = MAX, V _{IN} = 7.0 V			
I _{IL}	Input LOW Current Data, Clock Set, Clear			-0.4 -0.8	mA	V _{CC} = MAX, V _{IN} = 0.4 V			
I _{OS}	Output Short Circuit Current (Note 1)	-20		-100	mA	V _{CC} = MAX			
I _{CC}	Power Supply Current			8.0	mA	V _{CC} = MAX			

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

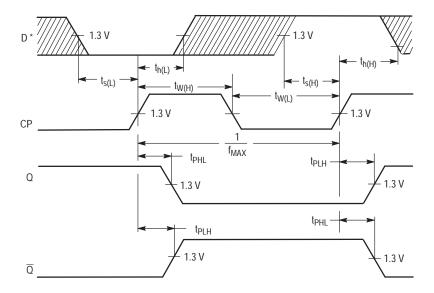
AC CHARACTERISTICS ($T_A = 25^{\circ}C$, $V_{CC} = 5.0 \text{ V}$)

		Limits						
Symbol	Parameter	Min	Тур	Max	Unit	Test Co	onditions	
f _{MAX}	Maximum Clock Frequency	25	33		MHz	Figure 1	.,,,	
t _{PLH}	Clock, Clear, Set to Output		13	25	ns	Figure 1	$V_{CC} = 5.0 \text{ V}$ $C_L = 15 \text{ pF}$	
t _{PHL}	Glock, Glear, Set to Gutput		25	40	ns	Figure 1	C _L = 13 μr	

$\label{eq:ac_setup} \textbf{AC SETUP REQUIREMENTS} \ (T_A = 25^{\circ}C)$

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
t _{W (H)}	Clock	25			ns	Figure 1	
t _{W (L)}	Clear, Set	25			ns	Figure 2	
	Data Setup Time — HIGH	20			ns	Figure 1	V _{CC} = 5.0 V
t _s	LOW	20			ns	Figure 1	
t _h	Hold Time	5.0			ns	Figure 1	

AC WAVEFORMS



 $^{^{\}star}$ The shaded areas indicate when the input is permitted to change for predictable output performance.

Figure 1. Clock to Output Delays, Data Set-Up and Hold Times, Clock Pulse Width

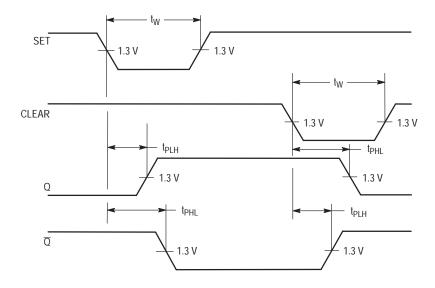
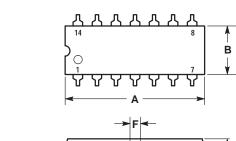
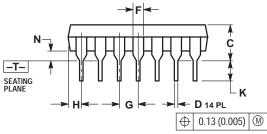


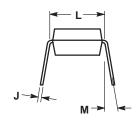
Figure 2. Set and Clear to Output Delays, Set and Clear Pulse Widths

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 646-06 ISSUE M





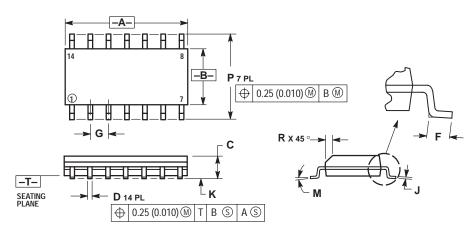


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.715	0.770	18.16	18.80	
В	0.240	0.260	6.10	6.60	
С	0.145	0.185	3.69	4.69	
D	0.015	0.021	0.38	0.53	
F	0.040	0.070	1.02	1.78	
G	0.100	BSC	2.54 BSC		
Н	0.052	0.095	1.32	2.41	
J	0.008	0.015	0.20	0.38	
K	0.115	0.135	2.92	3.43	
L	0.290	0.310	7.37	7.87	
M		10°		10°	
N	0.015	0.039	0.38	1.01	

PACKAGE DIMENSIONS

D SUFFIX PLASTIC SOIC PACKAGE CASE 751A-03 ISSUE F



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	8.55	8.75	0.337	0.344	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0 °	7°	0 °	7°	
Р	5.80	6.20	0.228	0.244	
R	0.25	0.50	0.010	0.019	

Notes

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